<u>S/N 09/650,566</u> <u>PATENT</u>

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant:

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Examiner: Thanh S. Phan

Serial No.:

09/650,566

Group Art Unit: 2841

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Title:

ELECTRONIC ASSEMBLY COMPRISING CERAMIC/ORGANIC HYBRID

SUBSTRATE WITH EMBEDDED CAPACITORS AND METHODS OF

MANUFACTURE

AMENDMENT AND RESPONSE UNDER 37 CFR § 1.111

Commissioner for Patents Washington, D.C. 20231

Applicants have reviewed the Office Action mailed on May 8, 2002. Please amend the above-identified patent application as follows.

IN THE CLAIMS

Please substitute the claim set in the appendix entitled "Clean Version of Pending Claims" for the previously pending claim set. The substitute claim set is intended to reflect amendment of previously pending claims 3, 5-6, 28 and 30, and the addition of new claims 31-40. Claims 1-10 and 28-40 are pending in this application. The specific amendments to individual claims are detailed in the following marked up set of claims.

- 3. (Amended) The multilayer substrate recited in claim 2, wherein the pitch of the second plurality of lands is greater than the pitch of the first plurality of lands, and wherein the pitch is increased within the organic <u>portion</u> [layer].
- 5. (Amended) The multilayer substrate recited in claim 4, wherein the pitch of the second plurality of lands is greater than the pitch of the first plurality of lands, and wherein the pitch is increased within the organic <u>portion</u> [layer].
- 6. (Twice Amended) The multilayer substrate recited in claim 2, wherein the third and fourth lands are positioned to couple to corresponding power supply nodes of an additional substrate <u>underlying</u> [subjacent to] the multilayer [ceramic] substrate.